UTT26N03-H Power MOSFET

26A, 30V N-CHANNEL POWER MOSFET

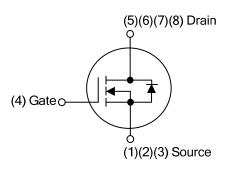
■ DESCRIPTION

The UTC **UTT26N03-H** is a N-channel power MOSFET using UTC's advanced technology to provide the customers with high switching speed and a minimum on-state resistance. It can also withstand high energy in the avalanche.

■ FEATURES

- * $R_{DS(ON)} \le 12 \text{ m}\Omega$ @ V_{GS} = 10V, I_{D} =10A $R_{DS(ON)} \le 18 \text{ m}\Omega$ @ V_{GS} =4.5V, I_{D} =10A
- * Improved dv/dt capability
- * Fast switching
- * Green device available

■ SYMBOL



ORDERING INFORMATION

Note: Pin Assignment: G: Gate

Ordering Number		Dealtage	Pin Assignment							Doolsing		
Lead Free	Halogen Free	Package	1	2	3	4	5	6	7	8	Packing	
UTT26N03L-P3030-R	UTT26N03G-P3030-R	PDFN3×3	S	S	S	G	D	D	D	D	Tube	

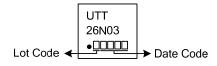
UTT26N03G-P3030-R

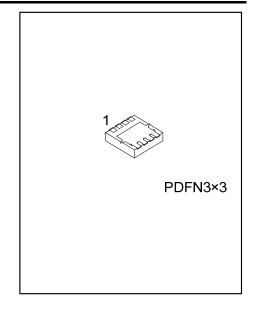
(1)Packing Type
(2)Package Type
(3)Green Package
(3) G: Halogen Free and Lead Free, K: Lead Free

S: Source

D: Drain

MARKING





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UTT26N03-H Power MOSFET

■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER			SYMBOL	RATINGS	UNIT	
Drain-Source Voltage			V_{DSS}	30	V	
Gate-Source Voltage			V_{GSS}	±12	V	
Continuous Drain Current	Continuous T	_C =25°C	I_{D}	26	Α	
Pulsed Drain Current	sed Drain Current Pulsed (Note 2)			104	Α	
Avalanche Energy, Single Pulsed (Note 3)			E _{AS}	16	mJ	
Peak Diode Recovery dv/dt (Note4)			dv/dt	1.5	V/ns	
Power Dissipation			P_D	35	W	
Junction Temperature			T_J	+150	°C	
Storage Temperature Range			T _{STG}	-55 ~ + 150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L=0.1mH, I_{AS} =18A, V_{DD} =25V, R_{G} =25 Ω , Starting T_{J} =25°C
- 4. $I_{SD} \le 26A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT		
Junction to Ambient	θ_{JA}	75	°C/W		
Junction to Case	θ_{JC}	3.7	°C/W		

Note: The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

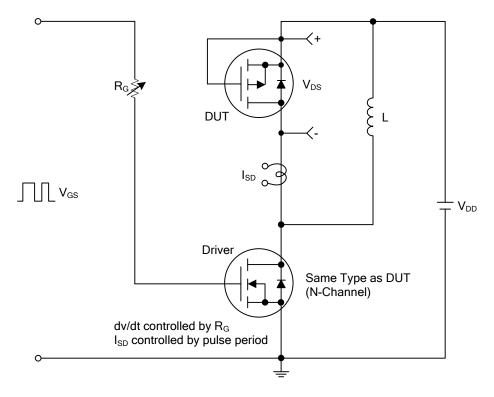
■ ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage		BV_{DSS}	V_{GS} =0V, I_D =250 μ A	30			V		
Drain-Source Leakage Current		I_{DSS}	V _{DS} =30V, V _{GS} =0V			1	μΑ		
Gate-Source Leakage Current	Forward	I _{GSS}	V _{DS} =0V ,V _{GS} =+12V			+100	nA		
	Reverse		V _{DS} =0V ,V _{GS} =-12V			-100	nA		
ON CHARACTERISTICS									
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	1.0		2.5	V		
Drain-Source On-State Resistance		D	V _{GS} =10V, I _D =10A			12	mΩ		
Dialii-Source Oil-State Resistance		R _{DS(ON)}	V _{GS} =4.5V, I _D =10A			18	mΩ		
DYNAMIC PARAMETERS									
Input Capacitance		C_{ISS}			750		pF		
Output Capacitance		Coss	V _{DS} =15V, V _{GS} =0V, f=1.0MHz		130		pF		
Reverse Transfer Capacitance		C_{RSS}			95		pF		
SWITCHING PARAMETERS									
Total Gate Charge (Note 1)		Q_G	V _{DS} =24V, V _{GS} =10V, I _D =26A		16		nC		
Gate to Source Charge		Q_GS	I_{G} =1mA (Note 1, 2)		8.8		nC		
Gate to Drain Charge		Q_GD	IG-IIIA (Note 1, 2)		1.6		nC		
Turn-on Delay Time (Note 1)		t _{D(ON)}			12		ns		
Rise Time		t_R	V _{DD} =15V, V _{GS} =10V, I _D =0.5A,		5.2		ns		
Turn-off Delay Time		t _{D(OFF)}	R _G =25Ω (Note 1, 2)		54		ns		
Fall-Time		t_{F}			38		ns		
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS									
Maximum Body-Diode Pulsed Current		Is				26	Α		
Drain-Source Diode Forward Voltage (Note 1)		I _{SM}				104	Α		
Maximum Body-Diode Continuous Current		V_{SD}	I _S =1.0A, V _{GS} =0V			1.0	V		
Reverse Recovery Time		t _{rr}	V _{GS} =0V, I _S =26A	250		nS			
Reverse Recovery Charge		Q_{rr}	dI _F /dt=100A/μs		0.33		μC		

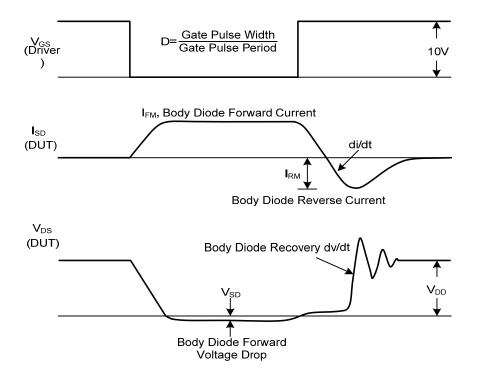
Note: 1. Pulse Test : Pulse width \leq 300 μ s, Duty cycle \leq 2%.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

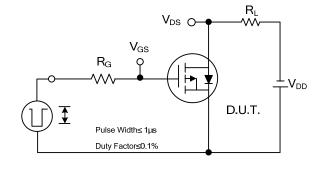


Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

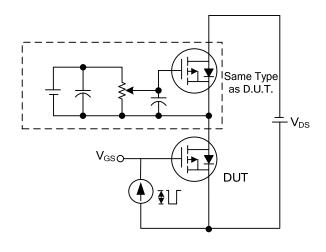
■ TEST CIRCUITS AND WAVEFORMS

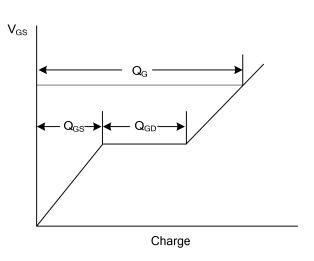


 V_{DS} 00% V_{GS} 10% $t_{D(OR)}$ t_{R} t_{R}

Switching Test Circuit

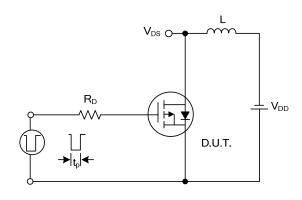
Switching Waveforms

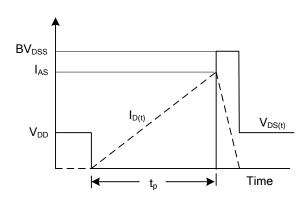




Gate Charge Test Circuit

Gate Charge Waveform



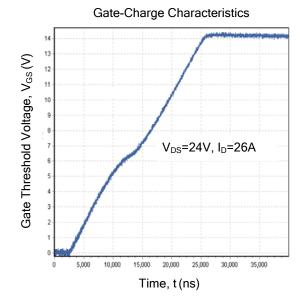


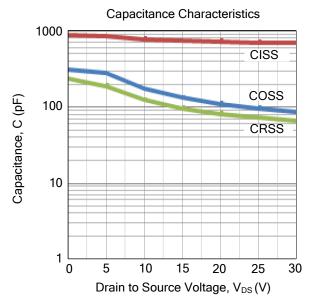
Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

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■ TYPICAL CHARACTERISTICS





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